

# JLPI50B120RE2F7SN

LE2 PACK module with Gen.7 Trench/Fieldstop IGBT and Emitter Controlled diode and NTC



## Features

### • Electrical features

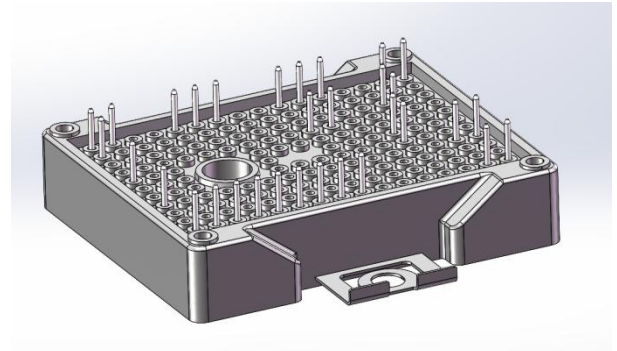
- $V_{CES} = 1200\text{ V}$
- $I_{C\text{ nom}} = 50\text{ A} / I_{CRM} = 100\text{ A}$
- Low  $V_{CESat}$
- $10\mu\text{s}$  short circuit capability
- Overload operation up to  $175^{\circ}\text{C}$

### • Mechanical features

- Integrated NTC temperature sensor
- Isolated heatsink using DBC technology
- Low inductance case
- Solder contact technology

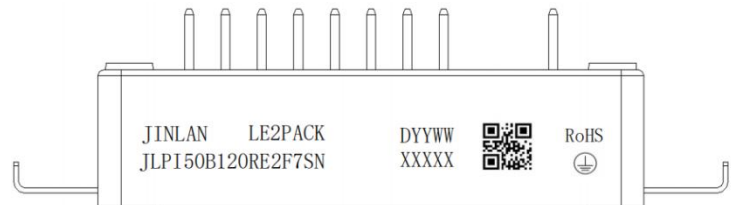
## Typical Applications

- Auxiliary inverters
- Motor drives
- Servo drives



LE2 Pack

## MARKING DIAGRAM



JINLAN

= Company Name

JLPI50B120RE2F7SN

= Specific Device Code

YYWW

= Year and Work Week Code

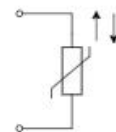
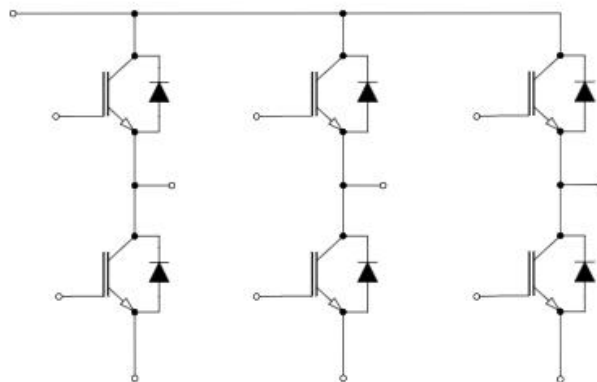
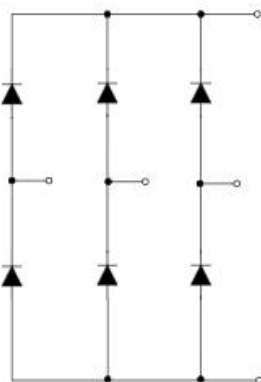
XXXXX

= Serial Number

QR code

= Custom Assembly Information

## Description





## Package Insulation coordination

| Parameter                                  | Symbol      | Note or test condition               | Values    | Unit |
|--------------------------------------------|-------------|--------------------------------------|-----------|------|
| Isolation test voltage                     | $V_{ISOL}$  | RMS, f=50Hz, t=60s                   | 2.5       | kV   |
| Internal isolation                         |             | basic insulation(class 1, IEC 61140) | $Al_2O_3$ |      |
| Creepage distance                          | $d_{creep}$ | terminal to heatsink                 | 11.5      | mm   |
| Clearance                                  | $d_{clear}$ | terminal to heatsink                 | 10        | mm   |
| Comparative tracking index<br>(electrical) | CTI         |                                      | >200      |      |
| RTI Elec.                                  | RTI         | housing                              | 140       | °C   |

## Package Characteristic values

| Parameter                                | Symbol        | Note or test condition         | Values |      |      | Unit |
|------------------------------------------|---------------|--------------------------------|--------|------|------|------|
|                                          |               |                                | Min.   | Typ. | Max. |      |
| Stray Inductance                         | LCE           |                                | --     | 35   | --   | nH   |
| Module Lead Resistance, Terminal to Chip | $R_{AA'+CC'}$ | $T_c=25^{\circ}C$ , per switch | --     | 6.0  | --   | mΩ   |
| Module Lead Resistance, Terminal to Chip | $R_{CC'+EE'}$ | $T_c=25^{\circ}C$ , per switch | --     | 5.0  | --   | mΩ   |
| Storage Temperature Range                | $T_{STG}$     |                                | -40    |      | 125  | °C   |
| Mounting Torque                          | F             | M5, Screw                      | 40     |      | 80   | N    |
| Weight                                   | G             |                                | --     | 39   | --   | g    |

**IGBT, Inverter****Absolute Maximum Ratings** (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol            | Description                                  | Value | Unit |
|-------------------|----------------------------------------------|-------|------|
| V <sub>CES</sub>  | Collector-Emitter Voltage                    | 1200  | V    |
| V <sub>GES</sub>  | Gate-Emitter Voltage                         | ±30   | V    |
| I <sub>C</sub>    | Collector Current @ T <sub>C</sub> =25°C     | 100   | A    |
|                   | Collector Current @ T <sub>C</sub> =80°C     | 50    | A    |
| I <sub>CM</sub>   | Pulsed Collector Current, t <sub>p</sub> =1s | 100   | A    |
| T <sub>Jmax</sub> | Maximum Junction Temperature                 | 175   | °C   |

**Characteristics** (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol               | Parameter                            | Test Condition                                                                                                                                                             | Min | Typ  | Max               | Unit |
|----------------------|--------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-------------------|------|
| V <sub>CE(sat)</sub> | Collector-Emitter Saturation Voltage | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 50 A, T <sub>vj</sub> = 25°C                                                                                                      | --  | 1.80 | 2.20              | V    |
|                      |                                      | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 50 A, T <sub>vj</sub> = 125°C                                                                                                     | --  | 1.95 | --                |      |
|                      |                                      | V <sub>GE</sub> = 15 V, I <sub>C</sub> = 50 A, T <sub>vj</sub> = 150°C                                                                                                     | --  | 2.00 | --                |      |
| V <sub>GE(TH)</sub>  | Gate-Emitter Threshold Voltage       | V <sub>GE</sub> = V <sub>CES</sub> , I <sub>C</sub> = 1 mA, T <sub>vj</sub> = 25°C                                                                                         | 5.0 | 6.0  | 7.0               | V    |
| I <sub>CES</sub>     | Collector-Emitter Cutoff Current     | V <sub>GE</sub> = 0 V, V <sub>CE</sub> = V <sub>CES</sub> , T <sub>vj</sub> = 25°C                                                                                         | --  | --   | 200               | μA   |
| I <sub>GES</sub>     | Gate-Emitter Leakage Current         | V <sub>GE</sub> = V <sub>GES</sub> , V <sub>CE</sub> = 0 V, T <sub>vj</sub> = 25°C                                                                                         | --  | --   | 200               | nA   |
| R <sub>Gint</sub>    | Internal Gate Resistance             |                                                                                                                                                                            | --  | 1.27 | --                | Ω    |
| C <sub>ies</sub>     | Input Capacitance                    | V <sub>CE</sub> =25V, f=1MHz,<br>V <sub>GE</sub> =0V                                                                                                                       | --  | 5.07 | --                | nF   |
| C <sub>res</sub>     | Reverse Transfer                     |                                                                                                                                                                            | --  | 0.13 | --                | nF   |
| Q <sub>G</sub>       | Gate Charge                          | V <sub>GE</sub> =15V, I <sub>C</sub> =50A                                                                                                                                  | --  | 0.19 | --                | μC   |
| t <sub>d(on)</sub>   | Turn-On Delay Time                   | V <sub>CC</sub> = 600 V, I <sub>C</sub> = 50 A<br>R <sub>Gon</sub> = 10Ω, R <sub>Goff</sub> = 25Ω<br>, V <sub>GE</sub> = ±15V<br>Inductive Load<br>T <sub>vj</sub> = 25°C  | --  | 110  | --                | ns   |
| t <sub>r</sub>       | Rise Time                            |                                                                                                                                                                            | --  | 30   | --                |      |
| t <sub>d(off)</sub>  | Turn-off Delay Time                  |                                                                                                                                                                            | --  | 180  | --                |      |
| t <sub>f</sub>       | Fall Time                            |                                                                                                                                                                            | --  | 190  | --                |      |
| E <sub>on</sub>      | Turn-On Switching Loss per Pulse     |                                                                                                                                                                            | --  | 2.83 | --                | mJ   |
| E <sub>off</sub>     | Turn Off Switching Loss per Pulse    |                                                                                                                                                                            | --  | 4.42 | --                |      |
| t <sub>d(on)</sub>   | Turn-On Delay Time                   | V <sub>CC</sub> = 600 V, I <sub>C</sub> = 50 A<br>R <sub>Gon</sub> = 10Ω, R <sub>Goff</sub> = 25Ω<br>, V <sub>GE</sub> = ±15V<br>Inductive Load<br>T <sub>vj</sub> = 125°C | --  | 120  | --                | ns   |
| t <sub>r</sub>       | Rise Time                            |                                                                                                                                                                            | --  | 30   | --                |      |
| t <sub>d(off)</sub>  | Turn-off Delay Time                  |                                                                                                                                                                            | --  | 230  | --                |      |
| t <sub>f</sub>       | Fall Time                            |                                                                                                                                                                            | --  | 340  | --                |      |
| E <sub>on</sub>      | Turn-on Switching Loss per Pulse     |                                                                                                                                                                            | --  | 4.16 | --                | mJ   |
| E <sub>off</sub>     | Turn Off Switching Loss per Pulse    |                                                                                                                                                                            | --  | 5.24 | --                |      |
| t <sub>d(on)</sub>   | Turn-On Delay Time                   | V <sub>CC</sub> = 600 V, I <sub>C</sub> = 50 A<br>R <sub>Gon</sub> = 10Ω, R <sub>Goff</sub> = 25Ω<br>, V <sub>GE</sub> = ±15V<br>Inductive Load<br>T <sub>vj</sub> = 150°C | --  | 110  | --                | ns   |
| t <sub>r</sub>       | Rise Time                            |                                                                                                                                                                            | --  | 40   | --                |      |
| t <sub>d(off)</sub>  | Turn-off Delay Time                  |                                                                                                                                                                            | --  | 240  | --                |      |
| t <sub>f</sub>       | Fall Time                            |                                                                                                                                                                            | --  | 330  | --                |      |
| E <sub>on</sub>      | Turn-on Switching Loss per Pulse     |                                                                                                                                                                            | --  | 4.87 | --                | mJ   |
| E <sub>off</sub>     | Turn Off Switching Loss per Pulse    |                                                                                                                                                                            | --  | 5.49 | --                |      |
| I <sub>SC</sub>      | SC Data                              | t <sub>p</sub> ≤ 10μs, V <sub>GE</sub> ≤ 15V,<br>T <sub>vj</sub> = 150°C, V <sub>CC</sub> = 800V,<br>V <sub>CEmax</sub> = V <sub>CES</sub> - L <sub>s</sub> CE·di/dt       | --  | 130  | --                | A    |
| R <sub>thJC</sub>    | Thermal resistance                   | Junction-to-Case (per IGBT)                                                                                                                                                | --  | 0.45 | --                | K/W  |
| T <sub>vj op</sub>   |                                      | Temperature under switching conditions                                                                                                                                     | -40 |      | 175 <sup>1)</sup> | °C   |

<sup>1)</sup>T<sub>vj op</sub> > 150°C is only allowed for operation at overload conditions. For detailed specifications please refer to AN 2018-14.



## Diode, Inverter

### Absolute Maximum Ratings (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol           | Description                                       | Value | Unit |
|------------------|---------------------------------------------------|-------|------|
| V <sub>RRM</sub> | Repetitive Peak Reverse Voltage                   | 1200  | V    |
| I <sub>F</sub>   | Diode Continuous Forward Current                  | 50    | A    |
| I <sub>FM</sub>  | Diode Maximum Forward Current t <sub>p</sub> =1ms | 150   | A    |

### Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

| Symbol             | Parameter                     | Test Condition                                                    |                       | Min | Typ  | Max               | Unit |
|--------------------|-------------------------------|-------------------------------------------------------------------|-----------------------|-----|------|-------------------|------|
| V <sub>F</sub>     | Diode Forward Voltage         | I <sub>F</sub> =50A                                               | T <sub>J</sub> =25°C  | --  | 1.80 | 2.70              | V    |
|                    |                               |                                                                   | T <sub>J</sub> =175°C | --  | 1.75 | --                |      |
| Q <sub>r</sub>     | Recovered Charge              | I <sub>F</sub> =50A,R <sub>g</sub> =25Ω,<br>T <sub>J</sub> =25°C  |                       | --  | 1.06 | --                | μC   |
| I <sub>RM</sub>    | Peak Reverse Recovery Current |                                                                   |                       | --  | 39.5 | --                | A    |
| T <sub>rr</sub>    | Reverse Recovery Time         |                                                                   |                       | --  | 126  | --                | ns   |
| E <sub>rec</sub>   | Reverse Recovery Energy       |                                                                   |                       | --  | 0.44 | --                | mJ   |
| Q <sub>r</sub>     | Recovered Charge              | I <sub>F</sub> =50A,R <sub>g</sub> =25Ω,<br>T <sub>J</sub> =175°C |                       | --  | TBD  | --                | μC   |
| I <sub>RM</sub>    | Peak Reverse Recovery Current |                                                                   |                       | --  | TBD  | --                | A    |
| T <sub>rr</sub>    | Reverse Recovery Time         |                                                                   |                       | --  | TBD  | --                | ns   |
| E <sub>rec</sub>   | Reverse Recovery Energy       |                                                                   |                       | --  | TBD  | --                | mJ   |
| R <sub>thJC</sub>  | Thermal resistance            | Junction-to-Case (per diode)                                      |                       | --  | 0.6  | --                | K/W  |
| T <sub>vj op</sub> |                               | Temperature under switching conditions                            |                       | -40 |      | 175 <sup>2)</sup> | °C   |

<sup>2)</sup>T<sub>vj op</sub> > 150°C is only allowed for operation at overload conditions. For detailed specifications please refer to AN 2018-14.

## Diode, Rectifier

### Absolute Maximum Ratings (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol           | Description                                       | Value | Unit |
|------------------|---------------------------------------------------|-------|------|
| V <sub>RRM</sub> | Repetitive Peak Reverse Voltage                   | 1600  | V    |
| I <sub>F</sub>   | Diode Continuous Forward Current                  | 50    | A    |
| I <sub>FM</sub>  | Diode Maximum Forward Current t <sub>p</sub> =1ms | 100   | A    |

### Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

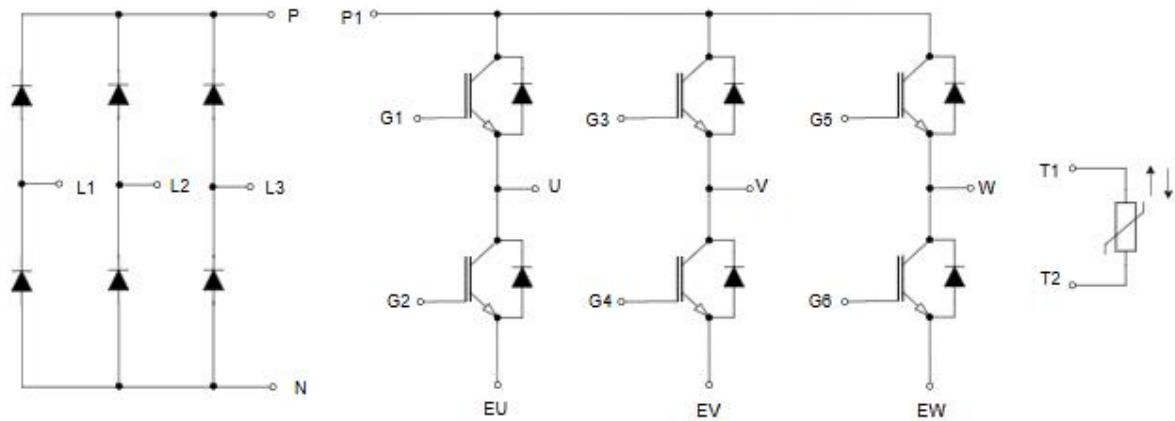
| Symbol             | Parameter             | Test Condition                                 | Min | Typ  | Max               | Unit |
|--------------------|-----------------------|------------------------------------------------|-----|------|-------------------|------|
| V <sub>F</sub>     | Diode Forward Voltage | I <sub>F</sub> = 50 A, T <sub>J</sub> = 150 °C | --  | 1.0  | --                | V    |
| I <sub>R</sub>     | Reverse Current       | T <sub>J</sub> =175 °C, V <sub>R</sub> =1600V  | --  | 3    | --                | mA   |
| R <sub>thJC</sub>  | Thermal resistance    | Junction-to-Case (per diode)                   |     | 0.53 |                   | K/W  |
| T <sub>vj op</sub> |                       | Temperature under switching conditions         | -40 |      | 175 <sup>3)</sup> | °C   |

<sup>3)</sup>T<sub>vj op</sub> > 150°C is only allowed for operation at overload conditions. For detailed specifications please refer to AN 2018-14.

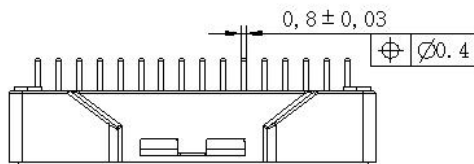
### NTC Characteristics (T<sub>C</sub> = 25°C unless otherwise noted)

| Symbol              | Parameter         | Test Condition                                                                            | Min | Typ  | Max  | Unit |
|---------------------|-------------------|-------------------------------------------------------------------------------------------|-----|------|------|------|
| R <sub>25</sub>     | Rated Resistance  |                                                                                           | --  | 5.0  | --   | kΩ   |
| ΔR/R                | Deviation of R100 | T <sub>C</sub> =100 °C, R <sub>100</sub> =493.3Ω                                          | -5  | --   | 5    | %    |
| P <sub>25</sub>     | Power Dissipation |                                                                                           | --  | --   | 20.0 | mW   |
| B <sub>25/50</sub>  | B-value           | R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/50</sub> (1/T <sub>2</sub> - 1/(298.15K))]  | --  | 3375 | --   | K    |
| B <sub>25/80</sub>  | B-value           | R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/80</sub> (1/T <sub>2</sub> - 1/(298.15K))]  | --  | 3411 | --   | K    |
| B <sub>25/100</sub> | B-value           | R <sub>2</sub> =R <sub>25</sub> exp[B <sub>25/100</sub> (1/T <sub>2</sub> - 1/(298.15K))] | --  | 3433 | --   | K    |

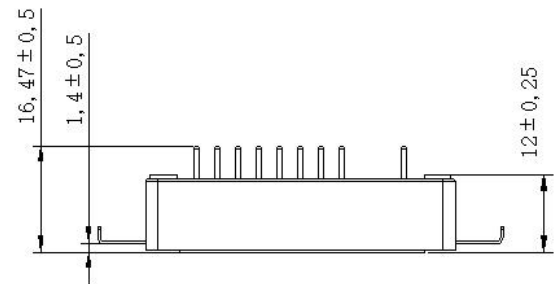
## CIRCUIT DIAGRAM



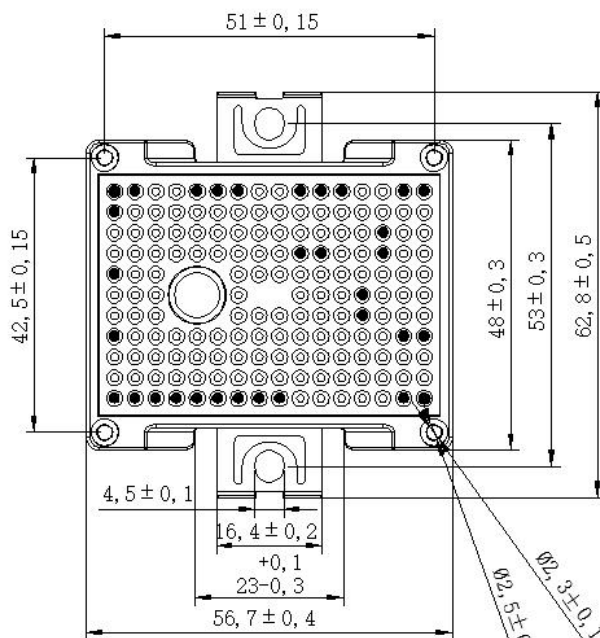
## PACKAGE DIMENSION



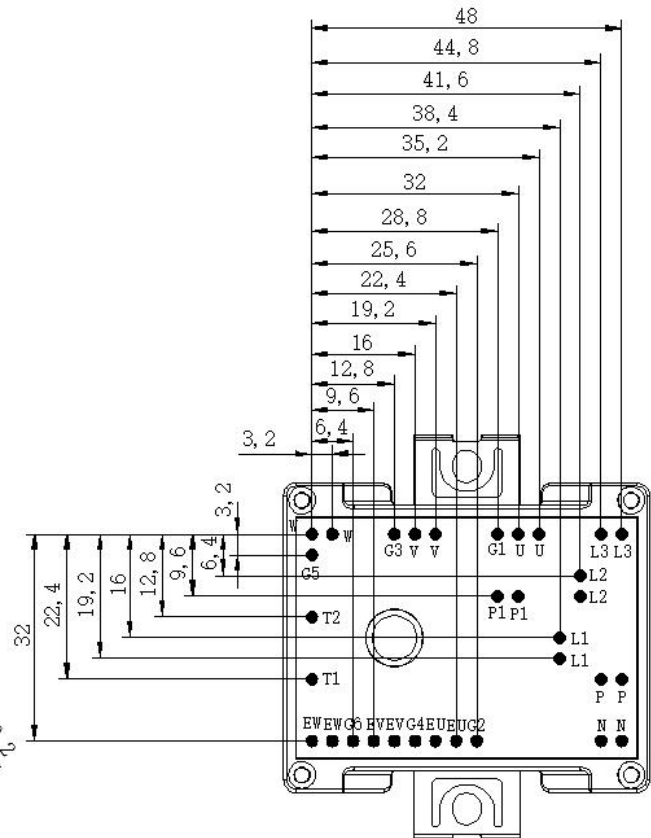
SIDE VIEW



SIDE VIEW



TOP VIEW





REVISION HISTORY

| Document version | Date of release | Description of changes         |
|------------------|-----------------|--------------------------------|
| Rev.00           | 2024-12-11      | Preview                        |
| Rev.01           | 2025-01-07      | Features content modifications |
|                  |                 |                                |



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